

FlexRay Transceiver





1 Overview

Features

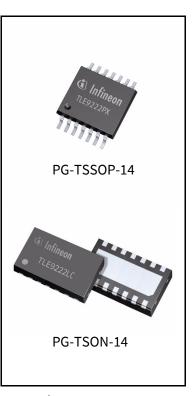
- Compliant with the FlexRay Electrical Physical Layer Specification version 3.0.1 and ISO 17458-4
- Optimized for time triggered in-vehicle networks with data transmission rates from 1 Mbit/s up to 10 Mbit/s
- Supports minimum bit times down to 60 ns
- Automatic voltage adaptation on the digital interface pins
- Bus failure protection and error detection
- Very high ESD robustness; ± 8 kV according to IEC61000-4-2
- Optimized for high Electromagnetic Compatibility (EMC);
 Very low emission and high immunity to interference
- Green Product (RoHS compliant)
- AEC Qualified
- Modes of Operation and Wake-up Features:
 - Low power standby operation mode with very low quiescent current consumption
 - Remote wake-up detection via wake-up patterns and a dedicated wake-up frame
- Protection and Diagnostic
 - Short-circuit protection on the bus pins
 - Overtemperature protection
 - Undervoltage monitoring of the V_{CC} power supply and the V_{IO} logic voltage level reference

1

- Error and wake-up indication on the ERRN output
- Status register for detailed diagnostic information through a simplified SPI interface
- Integrated Bus Guardian interface with enhanced safety feedback path
- Bus pins high impedance when device unpowered

Applications

- Engine Management
- Autonomous Driving
- Radar
- Gateway



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Overview

Description

The TLE9222 FlexRay transceiver is designed for data transmission rates from 1 Mbit/s up to 10 Mbit/s according to the FlexRay Electrical Physical Layer Specification 3.0.1. The Bus Driver (BD) realizes the physical interface between a FlexRay node and the communication channel. It provides differential transmit and receive capability to the bus, allowing the node bidirectional time-multiplexed binary data stream transfer. In addition to transmit and receive functions, the TLE9222 provides low power standby operation, supply voltage monitoring (undervoltage detection) as well as bus failure detection and represents an ESD-protection barrier between the bus and the ECU.

The TLE9222 supports the following FlexRay functional classes:

- Functional class "Bus driver bus guardian interface"
- Functional class "Bus driver logic level adaptation"
- Functional class "Bus driver remote wakeup"
- Functional class "Bus driver increased voltage amplitude transmitter"

In BD_Standby mode the quiescent current is decreased to a minimal level while still being able to detect wake-up requests on the bus.

Fail Safe features, like failure detection and the power supply monitoring, combined with an easy accessible status register support requirements for safety related applications with extended diagnostic features.

The TLE9222 is internally protected against transients on the bus pins, BP and BM. This makes it possible to use the TLE9222 for implementing ECUs without additional external bus protection circuitry while fulfilling ESD and ISO pulse requirements of car manufacturers. With its excellent EMC performance the TLE9222 provides a very high immunity against RF disturbances over a broad frequency range and transmits only a minimal level of electromagnetic emission onto the bus.

The TLE9222 is integrated in a RoHS compliant PG-TSSOP-14 and PG-TSON-14 package. Using the latest Infineon Smart Power Technology it is especially tailored to withstand the harsh conditions of the automotive environment and qualification according to the AEC-Q100 standard.

| Туре | Package | Marking |
|-----------|-------------|---------|
| TLE9222PX | PG-TSSOP-14 | 9222 |
| TLE9222LC | PG-TSON-14 | 9222 |

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Block diagram

2 Block diagram

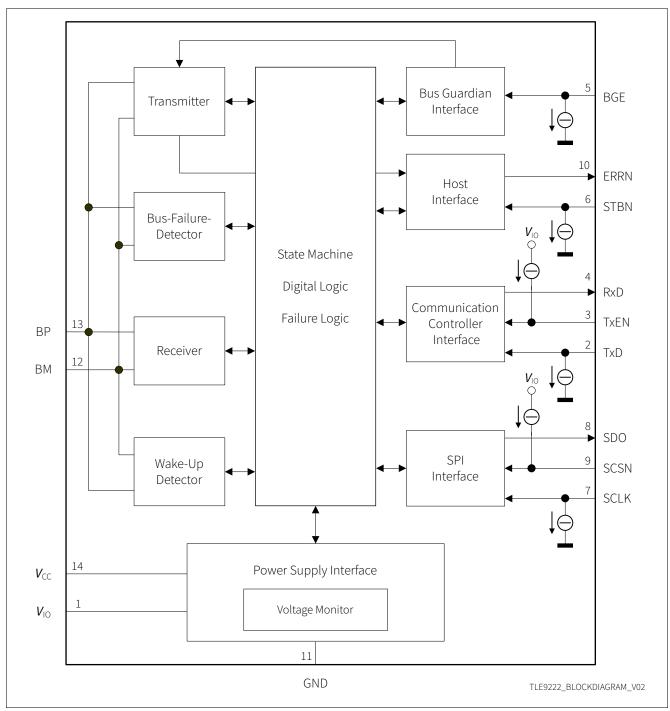


Figure 1 Block diagram



Pin configuration

3 Pin configuration

3.1 Pin assignment

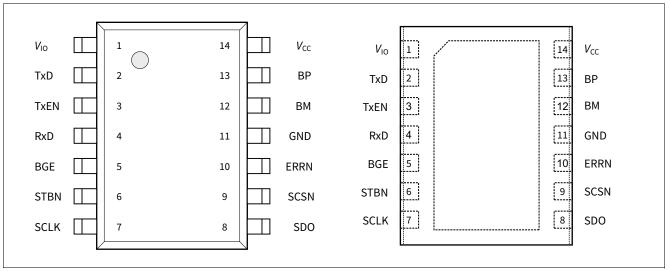


Figure 2 Pin configuration

3.2 Pin definitions and functions

| Pin | Symbol | Function |
|-----|-----------------|--------------------------------------------------------------------------------------------------------------------------------------------------|
| 1 | V _{IO} | Digital Reference Voltage; Digital reference voltage supply for the logic input and output pins, 100 nF decoupling capacitor to GND recommended. |
| 2 | TxD | Transmit Data Input; Integrated pull-down to GND. |
| 3 | TxEN | Transmitter Enable Not Input; Logical "low" to enable the transmitter output stage, Integrated pull-up to V_{10} . |
| 4 | RxD | Receive Data Output; Output voltage level adapted to the voltage level of V_{10} . |
| 5 | BGE | Bus Guardian Enable Input; Logical "high" to enable the transceiver output stage, Integrated pull-down to GND. |
| 6 | STBN | Standby Not Mode Control Input; Digital input for mode selection, logical "high" for BD_Normal mode, Integrated pull-down to GND. |
| 7 | SCLK | SPI Clock Input; Integrated pull-down to GND. |
| 8 | SDO | SPI Data Output; |
| 9 | SCSN | SPI Chip Select Not Input; Integrated pull-up to $V_{\rm IO}$. |

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Pin configuration

| Pin | Symbol | Function |
|-----|--------------|------------------------------------------------------------------|
| 10 | ERRN | Error Not Diagnosis Output; |
| | | Logical "low" in failure cases or when wake-up pattern detected. |
| 11 | GND | Ground; |
| 12 | ВМ | Bus Line Minus; |
| | | Negative input / output terminal of the FlexRay bus. |
| 13 | ВР | Bus Line Plus; |
| | | Positive input / output terminal of the FlexRay bus. |
| 14 | $V_{\rm cc}$ | Supply Voltage; |
| | | Transceiver 5V supply voltage, |
| | | 100 nF decoupling capacitors to GND recommended. |



Functional description

4 Functional description

The TLE9222 realizes the physical interface between the FlexRay node and the communication channel. Differential transmit and receive capability to the FlexRay bus is provided, allowing the node bidirectional time multiplexed binary data stream transfer.

The differential bus voltage is measured between two signal lines, denoted BP (Bus Plus) and BM (Bus Minus), defined as uBUS = uBP - uBM. Three different bus states are defined for the FlexRay bus; Idle, Data_0 and Data_1. For the Idle state no differential voltage is driven to BP or to BM. The common mode bus biasing level will depend on the operation mode of all nodes on the bus. For the Data_1 state a positive differential voltage is driven between BP and BM, whereas for the Data_0 state a negative differential voltage is driven between BP and BM.

4.1 Operation modes

The TLE9222 supports two functional operation modes, BD_Normal mode and BD_Standby mode. In addition, the BD_Off condition describes the behavior of the TLE9222 when unsupplied.

Mode transitions of the TLE9222 are triggered by host commands, undervoltage events and during power-up / -down, see **Figure 3** and **Table 1**.

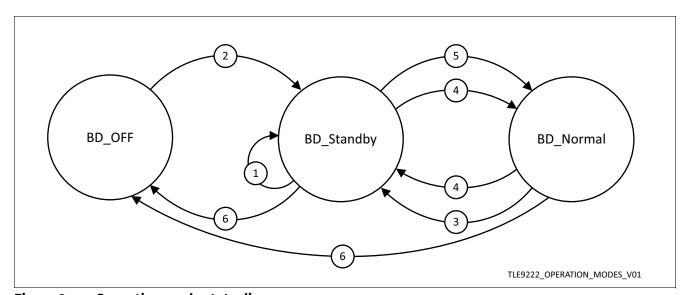


Figure 3 Operation mode state diagram

Table 1 Operation mode transitions

| Nr | Reason for transition | Comment | | |
|----|----------------------------------------------------------------------------------------------------------|----------------------------------------------------|--|--|
| 1 | Wake-up detection | - | | |
| 2 | Power-on detection Supply voltage sufficiently supplied via V_{CC} after being unpowered. | | | |
| 3 | Undervoltage detection After V_{cc} and / or V_{lo} undervoltage detection, BD_Standby mode is force | | | |
| 4 | Host command Triggered by host command. | | | |
| 5 | Undervoltage recovery Undervoltage recovery while host command requests BD_Normal mode | | | |
| 6 | Power-off | Supply voltage falls below the power-on threshold. | | |



Functional description

4.1.1 BD Normal mode

In BD_Normal mode all interfaces and functions of the TLE9222 are in operating condition. The communication controller interface is fully active; the RxD output reflects the data on the bus pins, the TxD drives the data to the transmitter and the TxEN input enables or disables the transmitter. When the transmitter is activated, fail safe functionality like the transmitter time-out, overtemperature detection and bus error detection are also enabled. The bus biasing is connected to $V_{\rm CC}$ / 2 via the internal common mode resistors. With the RxEN flag in the status register the bus states idle or active can be read out through the SPI interface.

The host interface is active and fully functional, as well as status register read-out on the SPI interface. Through the bus guardian interface, the transmitter can be activated or disabled.

The wake-up detector is active, but received wake-up information is not flagged while in BD_Normal mode.

The power supply interface including voltage monitor on both $V_{\rm CC}$ and $V_{\rm IO}$ is active. Undervoltage events are signalled on the ERRN output and in the status register, and trigger a mode transition to BD_Standby mode. BD_Normal mode can only be entered with a valid host command while both power supplies are within their operational range.

4.1.2 BD_Standby mode

After power-up the TLE9222 automatically enters BD_Standby, an idle mode with optimized low power consumption. In BD_Standby mode neither sending nor receiving data is possible, both the transmitter and the receiver are disabled. The bus biasing is connected to GND through the internal common mode resistors.

The communication controller interface is inactive. The TxD and the TxEN inputs are not functional. The RxD output is used for signalling wake-up or error information, depending on the host command. The host interface is active and fully functional, as well as status register read-out on the SPI interface.

The bus guardian interface is inactive and detection of bus transmission through the RxEN flag in the status register is not possible. The bus failure detector is not active, no bus failure can be detected.

The wake-up detector is active and signals wake-up requests on the ERRN and RxD outputs while the host command is BD_Standby mode.

The power supply interface with voltage monitoring on both $V_{\rm CC}$ and $V_{\rm IO}$ is active. If the TLE9222 is forced to BD_Standby mode because of undervoltage events while the host command is BD_Normal mode, this is signalled on the ERRN output. Additionally, the information is stored in the status register.

4.1.3 BD Off condition

The TLE9222 enters the BD_Off condition when the $V_{\rm CC}$ power supply drops below the $uBDPDV_{\rm CC}$ power-on-reset threshold. In this state the transmitter and the receiver are turned off, the wake-up function is not operational, the RxD and ERRN outputs are "low" and the SDO output is in high impedance state. If the $V_{\rm IO}$ reference supply is available, the logical inputs are set to their default states as given in **Table 2**.

Table 2 Logic inputs when unconnected / default states

| Input Signal | Default State |
|--------------|---------------|
| TxD | Low |
| TxEN | High |
| STBN | Low |
| BGE | Low |
| SCSN | High |
| SCLK | Low |



Functional description

4.2 Communication controller interface

The communication controller interface is the link between the TLE9222 and the FlexRay communication controller, comprising three digital signals:

- TxEN (Transmit Data Enable Not) input
- TxD (Transmit Data) input
- RxD (Receive Data) output

The logical I/O levels of all three digital pins are adapted to the V_{10} digital reference voltage supply.

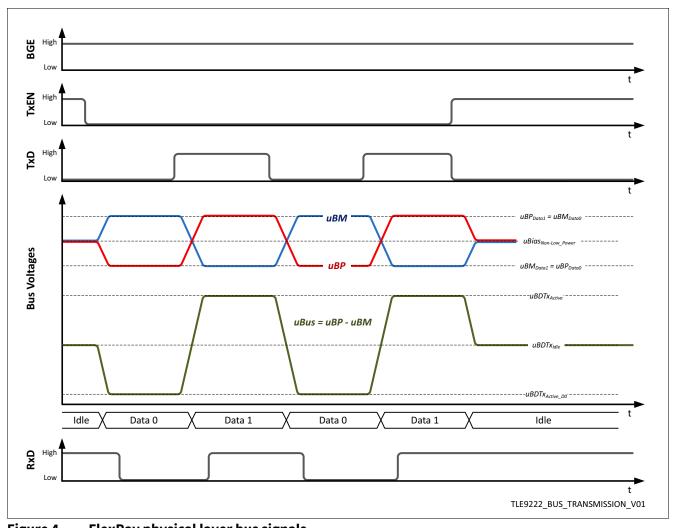


Figure 4 FlexRay physical layer bus signals

The communication controller interface drives the serial digital data stream available on the TxD input to the FlexRay bus via the transmitter. Simultaneously the receiver of the TLE9222 monitors the data on the FlexRay bus and transfers the data to a serial digital data stream back to the RxD output. A logical "low" signal on the TxD input drives a Data_0 signal on the FlexRay bus; a Data_0 signal on the FlexRay bus results in a logical "low" signal on the RxD output. Vice versa a logical "high" on TxD drives a Data_1 signal on the FlexRay bus and results in a logical "high" signal on the RxD output. The RxD output is also used to signal wake-up events while the transceiver is in BD_Standby mode.

The TxEN input is only functional in BD_Normal mode and requires a transition from "high" to "low" for initiating bus transmissions. After TxEN has been set "low" while the BGE input is "high", a "low" level on the TxD input enables the transmitter.

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For avoiding unintentional blocking of the FlexRay bus in case of failures, the transmitter is protected with a time-out function. In case a time-out occurs, the transmitter will automatically be disabled and the error will be signalled by the ERRN output and in the status register. A more detailed description of this fail safe function is given in **Chapter 4.7.3**.

4.3 Bus guardian interface

The bus guardian interface allows an external supervision device to immediate interrupt any bus transmission of the TLE9222. A logical "low" signal on the BGE input disables the transmitter of the TLE9222 while operating in BD_Normal mode, regardless of the signals on the TxD and TxEN inputs.

For increasing the ECU system safety level, an enhanced redundant feedback path has been implemented for the bus guardian interface. A monitoring circuit directly at the transmitter output stages provides reliable feedback by setting the ERRN output "low" and indication with the BGE flag in the status register after the transmitter has been disabled through the Bus Guardian interface.

The logical I/O level of the BGE input is adapted to the digital reference voltage level uV_{10} . Together with the TxEN input, the BGE input is monitored for the transmitter time-out function (see **Chapter 4.7.3**).

Additionally, the status register includes the RxEN (Receive Enable NOT) flag that indicates activity (Data_0 or Data_1) on the FlexRay bus. This detection is only active in BD_Normal Mode. The RxEN bit can be read out with the SPI Interface as described in **Chapter 4.8**.

4.4 Host interface

The host interface enables the host to control the operation mode of the TLE9222 and to flag status information. The host interface is implemented using *hard wired signals*, *Option A* according to the FlexRay EPL Spec. 3.0.1.

Table 3 Host command

| STBN | Resulting operation mode |
|------|--------------------------|
| High | BD_Normal |
| Low | BD_Standby |

The STBN (Standby Not) input controls the operation mode of the TLE9222. Unless the TLE9222 is being forced to BD_Standby mode because of undervoltage events, the host command will set operation mode as given in **Table 3**. Mode change by host command is completed within the time $dBD_{\text{ModeChange}}$ after the host command is applied. Voltage spikes on the STBN input that are shorter than $dBDLogic_{\text{Filter}}$ are filtered out and ignored.

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Functional description

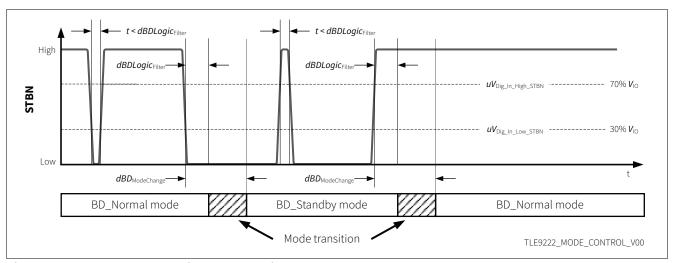


Figure 5 Mode control with the STBN input

The ERRN output is used to signal events detected by the TLE9222 to the host controller. Depending on the provided host command, the ERRN output indicates errors or wake-up events, see **Table 4**. The TLE9222 reacts on and signals these events on the ERRN output within the time *dReactionTime*_{ERRN}. Detailed information about the detected events as given in **Table 4** can be read out from the status register with the SPI interface as described in **Chapter 4.8**.

Table 4 Signalling on the ERRN and RxD pins

| STBN | ERRN | RxD | Cause / Comment | Effect | | |
|-----------------|---------|-----------------------------|---------------------------------------------|-------------------------------------------------------------------------------------------------------|--|--|
| BD_Nor | mal mod | le | | | | |
| High | High | High / Low ¹⁾ | Default condition for BD_Normal mode | _ | | |
| High | Low | High / | Bus error detected | - | | |
| | | Low ¹⁾ | Transmitter time-out detected | Transmitter disabled | | |
| | | | Overtemperature event detected | Transmitter disabled | | |
| | | | BGE input "low" | Transmitter disabled | | |
| | | | SPI error detected | - | | |
| BD_Sta | ndby mo | de | | | | |
| Low | High | High | Default condition for BD_Standby mode | - | | |
| Low | Low | Low | Bus wake-up detected | - | | |
| High | Low | High | V _{CC} undervoltage detected | Forced BD_Standby mode | | |
| X ²⁾ | Low | Low | V _{IO} undervoltage detected | Forced BD_Standby mode, logic inputs follow default states (see Table 2) SDO "high impedance" | | |
| BD_OFF | conditi | on | | | | |
| X ²⁾ | Low | Low | uV _{cc} below uBDPDV _{cc} | - | | |

¹⁾ Depending on bus state; RxD "low" when Data_0 is detected, RxD "high" when Data_1 is detected or when bus is Idle

²⁾ X = "Don't care"

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A "low" output level on the ERRN pin is latched. To reset the ERRN event and the status register either a correct read-out of the status register or a mode change by the host command is required, given that the error condition has been resolved.

4.5 Power supply interface

The TLE9222 is powered by the $V_{\rm CC}$ pin which shall be connected to a voltage supply with nominal 5 V. Additionally, the TLE9222 provides the $V_{\rm IO}$ reference voltage pin for all digital inputs and outputs. The voltages at the $V_{\rm CC}$ and $V_{\rm IO}$ pins are monitored for detection of undervoltage events.

4.5.1 *V*_{CC} undervoltage detection

The TLE9222 detects undervoltage events on the $V_{\rm CC}$ pin if the voltage $uV_{\rm CC}$ falls below the undervoltage detection threshold $uBDUVV_{\rm CC}$ for a time $t > dBDUVV_{\rm CC_blk}$. Upon detection the $V_{\rm CC}$ -undervoltage flag and the error flag are set. In case the TLE9222 is in BD_Normal mode, the transmitter will be disabled and the ERRN output will go "low" after the time $dReactionTime_{\rm ERRN}$. After the time $dBDUVV_{\rm CC}$ the TLE9222 will force a transition to BD_Standby, regardless of the host command (see **Figure 6**).

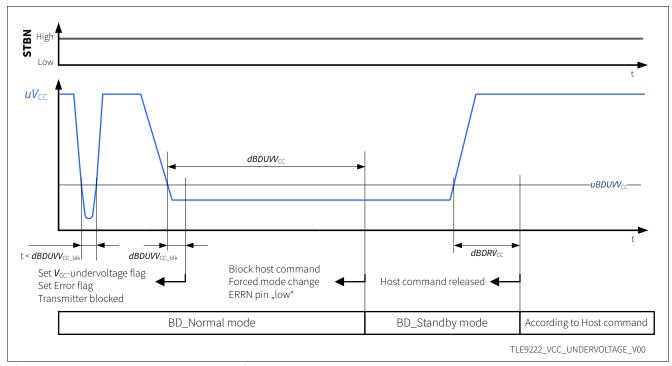


Figure 6 V_{cc} undervoltage detection

The TLE9222 recovers from a V_{CC} undervoltage event after the time $t > dBDRV_{CC}$ following the voltage uV_{CC} rise above the undervoltage detection threshold $uBDUVV_{CC}$. This will release the host command and change operation mode accordingly.

4.5.2 V₁₀ undervoltage detection

The $V_{\rm IO}$ undervoltage detection is similar to that on the $V_{\rm CC}$ supply. Undervoltage events on the $V_{\rm IO}$ pin are detected if the voltage $uV_{\rm IO}$ falls below the undervoltage detection threshold $uUV_{\rm IO}$ for a time $t > dBDUVV_{\rm IO_blk}$. Upon detection the $V_{\rm IO}$ -undervoltage flag and the error flag are set. While an undervoltage event is present on the $V_{\rm IO}$ pin, the reference threshold levels of all digital input and output pins are invalid. Therefore, the TLE9222 blocks the host interface, communication controller interface, SPI interface and the bus guardian interface. The digital outputs RxD and ERRN are set "low" and all digital input pins follow their default levels

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Functional description

(see **Table 2**). The SDO output is set to high impedance state. After the time *dBDUVV*_{IO} the TLE9222 will force a transition to BD_Standby mode.

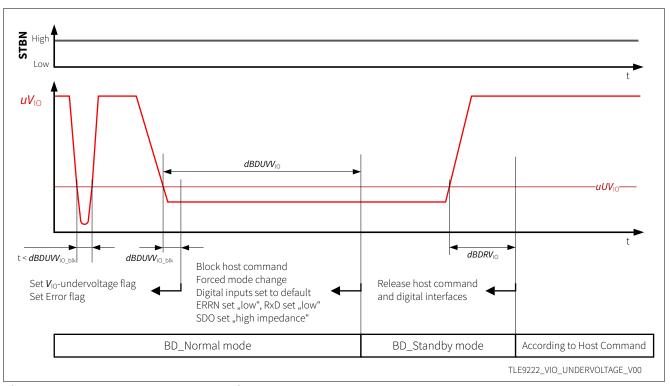


Figure 7 V₁₀ undervoltage detection

The TLE9222 will recover from a V_{IO} undervoltage event after the time $t > dBDRV_{IO}$ following the voltage uV_{IO} rise above the undervoltage detection threshold uUV_{IO} . This will release the SPI interface and host command, and change mode accordingly (see **Figure 7**).

4.5.3 Power-up and power-down

The TLE9222 will remain in BD_Off condition as long as the voltage on the $V_{\rm CC}$ supply pin, $uV_{\rm CC}$, is below the power-down threshold $uBDPDV_{\rm CC}$. When $uV_{\rm CC}$ is ramped up higher than $uBDPDV_{\rm CC}$ the TLE9222 powers up and begins initialization of the BD_Standby mode within the time $dBD_{\rm Power}$. After both voltages $uV_{\rm CC}$ and $uV_{\rm IO}$ have risen above their respective undervoltage detection thresholds ($uBDUVV_{\rm CC}$ and $uUV_{\rm IO}$, respectively), the digital interfaces will be released and the full functionality of the device will be available. The power-on event can be identified with the corresponding flag in the status register and mode change according to the host command will then be initiated (see **Figure 8**).



Functional description

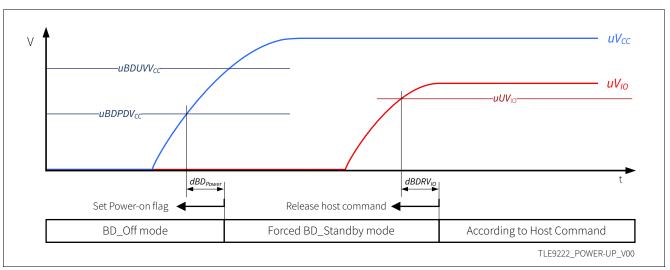


Figure 8 Power-up behavior

The power-down sequence of the TLE9222 is shown in **Figure 9**. As the voltage at the V_{CC} supply pin, uV_{CC} , falls below the undervoltage threshold the V_{CC} -undervoltage flag and the error flag are set. After the detection time for V_{CC} undervoltage $dBDUVV_{CC}$ the TLE9222 blocks the host command and automatically enters BD_Standby mode.

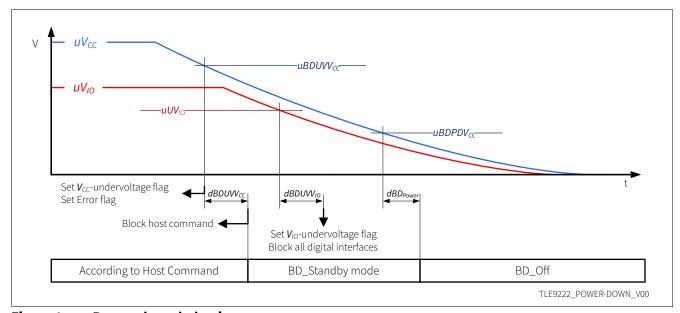


Figure 9 Power-down behavior

While the TLE9222 is being powered down, the behavior on the digital interface level shift reference pin V_{10} is very similar to the V_{CC} supply pin. As uV_{10} falls below the undervoltage threshold the undervoltage timer is started and the V_{10} -undervoltage flag is set. If V_{CC} is not already in undervoltage condition, the error flag is also set. After the detection time for V_{10} undervoltage, $dBDUVV_{10}$, the TLE9222 blocks the host command (if not already blocked because of V_{CC} undervoltage) and all digital interfaces and enters BD_Standby mode.

When the voltage at the V_{CC} supply pin, uV_{CC} , falls below the power-on threshold $uBDPDV_{CC}$ the TLE9222 enters BD_Off condition within the time dBD_{Power} .



Functional description

4.6 Remote wake-up

The TLE9222 detects and signals a remote wake-up request after correct reception of a bus wake-up pattern or wake-up payload in a FlexRay data frame while operating in BD_Standby mode. When the valid wake-up pattern or wake-up payload is detected, the TLE9222 signals the request with the remote wake-up flag in the status register and on the RxD and ERRN outputs within the time *dBDWakeupReaction*_{Remote}.

The wake-up detector is also active in BD_Normal mode, but wake-up requests are only flagged when the TLE9222 is in BD_Standby mode.

4.6.1 Bus wake-up patterns

A wake-up pattern consists of at least two wake-up symbols. A wake-up symbol on the FlexRay bus is defined as either a phase of Data_0 followed by a phase of Idle, or alternatively as a phase of Data_0 followed by a phase of Data_1. A valid remote wake-up event is detected with the reception of at least two consecutive wake-up symbols on the bus within the time dWU_{Timeout} (see **Figure 10** and **Figure 11**).

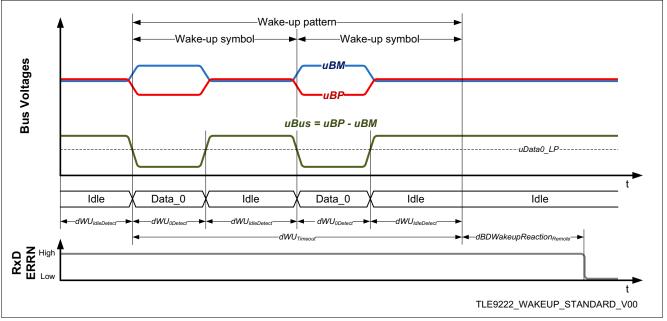


Figure 10 Standard wake-up pattern

The Data_0 phases have to be longer than the time $dWU_{0Detect}$ while the Idle or Data_1 (alternative wake-up pattern) phases have to be longer than the time $dWU_{IdleDetect}$. The TLE9222 detects and signals both the standard and the alternative wake-up patterns without any behavioral differences.



Functional description

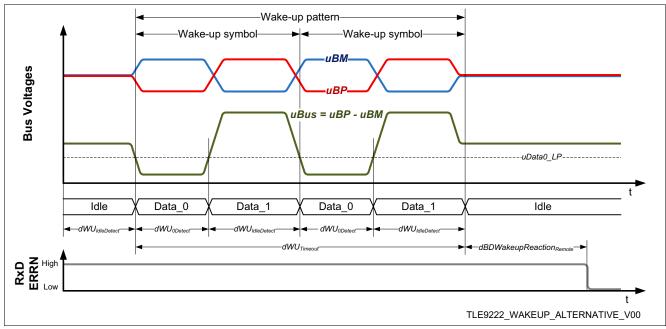


Figure 11 Alternative wake-up pattern

4.6.2 Wake-up by payload

In addition to wake-up detection by wake-up patterns, the TLE9222 also supports wake-up requests by a specific payload within the data field of a FlexRay communication frame with data transmission rate of 10 Mbit/s.

A dedicated Byte Start Sequence (BSS) is transmitted before each byte of the payload within the FlexRay data frame. The BSS consists of one "high" bit followed by one "low" bit. For transmitting a "Data_0" byte on the FlexRay bus, the FlexRay controller sends 10 bits, the "high" bit and the "low" bit as part of the BSS followed by the eight "low" data bits (HL=BSS; LLLLLLLL= "Data_0"). For sending a "Data_1" byte the FlexRay controller sends the "high" bit and the "low" bit, followed by the eight consecutive "high" data bits (HL=BSS; HHHHHHHHH = "Data_1") (see Figure 12).

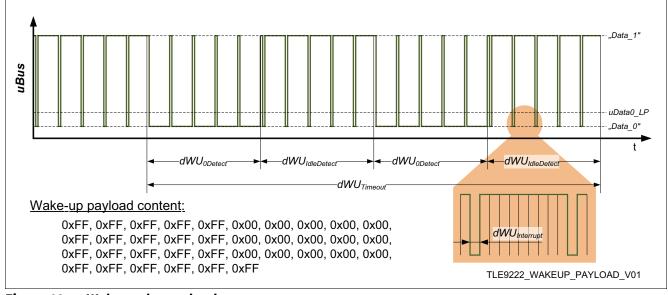


Figure 12 Wake-up by payload

(infineon

Functional description

4.7 Fail safe functions and flags

In addition to power supply undervoltage detection, the TLE9222 provides several functions for detection of local or remote failures with corresponding status flags. These errors are signalled with the ERRN output and can be read out from the status register. When local errors are detected, the TLE9222 initiates fail safe procedures for device self protection and prevention of communication channel interruption.

4.7.1 Overtemperature detection

The transmitter of the TLE9222 is protected against overtemperature events when active in BD_Normal mode. If the junction temperature rises above the $T_{J(warning)}$ threshold the temperature-warning flag in the status register is set. If the junction temperature continues to rise and exceeds the $T_{J(Shut_Down)}$ threshold, the transmitter will be disabled and the overtemperature event will be flagged by the temperature-high flag in the status register and signalled with the ERRN output.

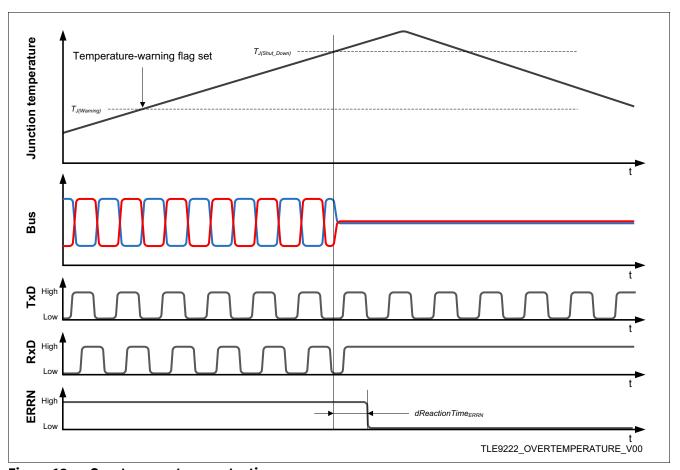


Figure 13 Overtemperature protection

4.7.2 Bus error detector

The bus error detector monitors the FlexRay bus for identifying external failures which may lead to corrupt data transmission and reception. With the RxD-TxD compare function and the bus overcurrent monitoring, bus errors are detected and signalled with the bus error flag. The bus error detector is only enabled in BD_Normal mode while the transmitter is active.

FlexRay Transceiver



Functional description

4.7.2.1 RxD-TxD compare

When the TLE9222 transmits data on the bus (TxEN "low" and BGE "high"), the digital input data on TxD is compared with the received data on the RxD output. If the data is not identical, a failure condition is identified.

Both the positive and the negative edges on the TxD input signal triggers an internal comparator to compare the TxD signal with the RxD signal. The results are stored in an internal error counter. When the internal error counter exceeds 10 reported comparison failures, the bus error flag will be set. The error counter is reset when the transmitter is deactivated.

4.7.2.2 Bus overcurrent

The BP and BM bus pins have implemented current sensors for detection of overcurrent conditions in the direction in or out of the pins. Detection of overcurrent is the typical signature of a short circuit of one of the bus lines to the ground or a supply line.

4.7.3 Transmitter time-out

For avoiding unintentional blocking of the FlexRay bus in case of e.g. a malfunctioning microcontroller or short circuits on the PCB, the transmitter is protected with a time-out function. When the transmitter is activated for bus transmission while in BD_Normal mode, with a "low" signal on TxEN and "high" on BGE, a timer is started. In case a time-out occurs, the transmitter will automatically be disabled and the failure will be signaled on the ERRN output and in the status register.

The transmitter timer is reset when the transmitter is deactivated with either TxEN or BGE.

4.7.4 V₁₀ undervoltage flag

During V_{10} undervoltage events, the SPI register is blocked and can not be read out. After undervoltage recovery, depending on host command and the status of other register flags, the V_{10} -undervoltage flag may or may not be set. Please refer to **Chapter 4.7.6**.

4.7.5 SPI-error flag

The SPI-error flag is used for indication of incorrect SPI read-out procedure, please find detailed description in **Chapter 4.8.1**.

4.7.6 Error flag

If any local errors or bus errors are detected, the respective bit in the status register is flagged together with the error flag (bit 12). If the error flag is set, but no other error contributing flags in the status register set, then this indicates that a V_{10} undervoltage event has occurred in the past but recovery has already taken place.

While the error flag is set and the host command on the STBN input is "high", the ERRN output is "low".

4.7.7 Mode flags

The mode flag in the status register indicates the current operating mode of the TLE9222, regardless of the applied host command. If the TLE9222 is in BD_Standby mode, bit 1 will be "low". If the current operation mode is BD_Normal, bit 1 will be "high". The mode flag will only toggle during an operation mode change, i.e. not be reset by SPI register read-out. The mode indication can be beneficial for the host when the TLE9222 is forced to a different mode than requested with the host command during V_{CC} undervoltage events.

FlexRay Transceiver



Functional description

4.8 SPI interface and status register

The TLE9222 has a 16-bit SPI interface for reading out the internal status register. The bits in the register reflects detailed flags regarding external events such as wake-up and power-on recognition, detection of errors / warnings and operation mode indication, see **Table 5**.

Table 5 Bit definition of the status register

| Bit | Name | Indication | Comment | |
|--------|--------------------------------------|--------------------------------------------------------------------------------|-------------------------------------------------------------------|--|
| Bit 0 | Remote wake-up | "Low": Remote wake-up detected | - | |
| | flag | "High": - | - | |
| Bit 1 | Mode flag | "Low": BD_Standby mode | - | |
| | | "High": BD_Normal mode | - | |
| Bit 2 | BGE flag | "Low": Transmitter disabled by Bus Guardian, BGE input "low" in BD_Normal mode | Error, will trigger Bit 12 → "low" | |
| | | "High": - | - | |
| Bit 3 | RxEN flag | "Low": Bus activity ongoing | Not latched | |
| | | "High": Bus idle | - | |
| Bit 4 | Power-on flag | "Low": Power-on detected | - | |
| | | "High": - | - | |
| Bit 5 | Bus-error flag | "Low": Bus error detected | Error, will trigger Bit 12 → "low" | |
| | | "High": - | - | |
| Bit 6 | Temperature-high flag | "Low": Overtemperature detected | Error, will trigger Bit 12 → "low" | |
| | | "High": - | - | |
| Bit 7 | Transmitter time- | "Low": Transmitter activation time-out | Error, will trigger Bit 12 → "low" | |
| | out flag | "High": – | - | |
| Bit 8 | <i>V</i> _{CC} -undervoltage | "Low": V _{CC} Undervoltage detected | Error, will trigger Bit 12 → "low" | |
| | flag | "High": - | - | |
| Bit 9 | V _{IO} -undervoltage | "Low": V _{IO} Undervoltage detected | Error, will trigger Bit 12 → "low" | |
| | flag | "High": - | - | |
| Bit 10 | SPI-error flag | "Low": SPI error detected | Error, will trigger Bit 12 → "low" | |
| | | "High": - | - | |
| Bit 11 | Temperature- | "Low": High temperature warning | - | |
| | warning flag | "High": - | - | |
| Bit 12 | Error flag | "Low": Error(s) detected | Error, will trigger ERRN output "low" if signal on STBN is "high" | |
| | | "High": No errors detected | - | |
| Bit 13 | Reserved | Always "High" | - | |
| Bit 14 | Reserved | Always "Low" | - | |
| Bit 15 | Even parity bit | "Low": Odd parity of Bit 0 to Bit 14 | - | |
| | | "High": Even parity of Bit 0 to Bit 14 | - | |

All the flags in the status register are "active low", the default level is "high".

FlexRay Transceiver



Functional description

The RxEN flag indicates ongoing bus transmission. As soon as the bus state returns to idle, this flag is set "high".

The wake-up, power-on and error flags and their corresponding status register bits are latched "low". A mode change by host command or a correct SPI status bit register read-out will reset these flags, given that the error condition has been resolved.

4.8.1 Read-out procedure

The SPI interface of the TLE9222 is enabled by the SCSN (SPI Chip Select Not) input. While SCSN is "high", the SDO (SPI Data Output) output is in a high impedance state and clock signals on the SCLK input are ignored. The read-out procedure is initiated with a "low" signal on SCSN, which will cause the SDO output to be set "low" (see **Figure 13**). After the time $dSPI_{Lead}$ the status register data can be shifted out on the SDO output synchronized with the rising edge of a clock signal on the SCLK input. With a clock signal period of $dSPI_{Clk}$, the TLE9222 supports SPI data rates in the range 10 kbit/s to 4 Mbit/sIf a transition on SCSN from "high" to "low" is detected while SCLK is "high", this would be identified as a SPI error.

Within the SCSN period, the time $dSPI_{SCSN_Low}$ while the signal on SCSN is "low", exactly 16 clock cycles are expected for a correct read-out procedure. Incorrect SPI access, with more or less than 16 SCLK cycles or wrong timing, is protected by the SPI timer. If the read-out time $dSPI_{SCSN_Low}$ expires, the SDO output is set to "high impedance" within the time $dSPI_{SDOZ}$. Additionally the error flag and SPI-error flag in the status register will be set, while the state of all other latched bits are left unchanged.

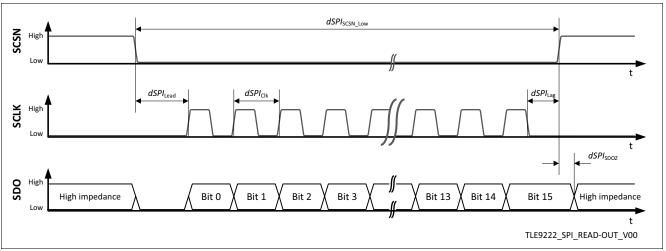


Figure 14 SPI read-out

After a correct SPI read-out process, the information on the ERRN output and the flags in the status register are refreshed. Next SPI read-out can be initiated after SCSN is set "high" for the time $dSPI_{Interframe}$.

The SPI interface is available in both BD_Normal mode and BD_Standby mode, but SPI readout should not occur at the same time as a mode change with the host interface, the time $dBD_{ModeChange}$ must be respected. The SPI register is also blocked during undervoltage conditions on V_{10} .

While the TLE9222 is set in BD_Standby with host command (pin STBN = "low") and no wake-up or errors have been detected, the SPI interface requires an enable time of $dSPI_{LeadStbOK}$ from SCSN goes "low" until the first rising edge on the clock signal on the SCLK input can be applied.



General product characteristics

5 General product characteristics

5.1 Absolute maximum ratings

Table 6 Absolute maximum ratings¹⁾

All voltages with respect to ground, positive current flowing into pin; (unless otherwise specified)

| Parameter | Symbol | Values | | | Unit | Note or | Number |
|--------------------------------------------------------------------|-------------------------|--------|------|-------------------------------|------|-------------------|----------|
| | | Min. | Тур. | Max. | | Test Conditio | |
| | | | | | | n | |
| Voltages | 1 | 1 | | 1 | 1 | 1 | 1 |
| Supply Voltage V _{CC} | uV_{CC} | -0.3 | - | 6.0 | V | - | P_5.1.1 |
| Digital Reference Voltage $V_{\rm IO}$ | uV_{10} | -0.3 | _ | 6.0 | V | - | P_5.1.2 |
| DC voltage on pin BP | uBP | -40 | - | 40 | V | - | P_5.1.3 |
| DC voltage on pin BM | иВМ | -40 | - | 40 | V | _ | P_5.1.4 |
| DC voltage on logic input pins TxD, TxEN, BGE, STBN, SCSN, SCLK | uV _{Logic_in} | -0.3 | _ | 6.0 | V | - | P_5.1.5 |
| DC voltage on logic output pins RxD, ERRN, SDO | uV _{Logic_out} | -0.3 | - | <i>uV</i> ₁₀ + 0.3 | V | - | P_5.1.6 |
| Currents | 1 | | | | 1 | | |
| Output Current on pin RxD | iRxD | -40 | _ | 40 | mA | _ | P_5.1.7 |
| Output Current on pin ERRN | iERRN | -40 | _ | 40 | mA | - | P_5.1.8 |
| Output Current on pin SDO | iSDO | -40 | _ | 40 | mA | _ | P_5.1.9 |
| Temperature | ı | | | 1 | | | |
| Junction Temperature | T _i | -40 | - | 150 | °C | _ | P_5.1.10 |
| Storage Temperature | $T_{\rm stg}$ | -55 | - | 150 | °C | _ | P_5.1.11 |
| ESD Susceptibility | | | | | | | |
| ESD Susceptibility to GND on BP and BM | uESD _{Ext} | -8 | _ | 8 | kV | HBM ²⁾ | P_5.1.12 |
| ESD Susceptibility to GND all other pins | uESD _{Int} | -2 | - | 2 | kV | HBM ²⁾ | P_5.1.13 |
| ESD Susceptibility to GND all pins | uESD _{CDM} | -750 | - | 750 | V | CDM ³⁾ | P_5.1.14 |
| | | | | | | | |

- 1) Not subject to production test, specified by design
- 2) ESD susceptibility, HBM according to ANSI/ESDA/JEDEC JS001 (1.5k Ω, 100 pF)
- 3) ESD susceptibility, Charged Device Model "CDM" ESDA STM5.3.1 or ANSI/ESD S.5.3.1

Notes

- 1. Stresses above the ones listed here may cause permanent damage to the device. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.
- 2. Integrated protection functions are designed to prevent IC destruction under fault conditions described in the data sheet. Fault conditions are considered as "outside" normal operating range. Protection functions are not designed for continuous repetitive operation.



General product characteristics

5.2 Functional range

Table 7 Operating range

| Parameter | Symbol | Symbol Values | | 5 | Unit | Note or | Number |
|-------------------------------------------|----------------|---------------|------|------|------|-----------------------|---------|
| | | Min. | Тур. | Max. | | Test Condition | |
| Supply Voltage V _{CC} | uV_{CC} | 4.75 | - | 5.25 | V | _ | P_5.2.1 |
| Digital Reference Voltage V _{IO} | uV_{10} | 3.0 | _ | 5.25 | V | _ | P_5.2.2 |
| Junction Temperature | T _J | -40 | - | 150 | °C | _ | P_5.2.3 |

Note:

Within the functional or operating range, the IC operates as described in the circuit description. The electrical characteristics are specified within the conditions given in the Electrical Characteristics table.

5.3 Thermal resistance

Note:

This thermal data was generated in accordance with JEDEC JESD51 standards. For more information, go to www.jedec.org.

Table 8 Thermal resistance¹⁾

| Parameter | Symbol | | Value | s | Unit | Note or Test Condition | Number |
|-----------------------------|-------------------------|------|-------|------|------|---------------------------|----------|
| | | Min. | Тур. | Max. | | | |
| Thermal Resistance | <u> </u> | | | | | | <u>'</u> |
| Junction to Ambient | R_{thJA} | - | 120 | - | K/W | PG-TSSOP-14 ²⁾ | P_5.3.1 |
| Junction to Ambient | R _{thJA} | _ | 45 | _ | K/W | PG-TSON-14 ²⁾ | P_5.3.5 |
| Thermal Shutdown Junction T | emperature | | | | • | | |
| Thermal warning temp. | $T_{\text{J(warning)}}$ | 150 | 160 | 170 | °C | _ | P_5.3.2 |
| Thermal shut-down temp. | $T_{J(Shut_Down)}$ | 170 | 180 | 190 | °C | _ | P_5.3.3 |
| Thermal shutdown hysteresis | ΔΤ | _ | 6 | _ | K | _ | P_5.3.4 |

¹⁾ Not subject to production test, specified by design

²⁾ Specified R_{thJA} value is according to Jedec JESD51-2,-7 at natural convection on FR4 2s2p board; The TLE9222 was simulated on a 76.2 x 114.3 x 1.5 mm board with 2 inner copper layers (2 x 70 μ m Cu, 2 x 35 μ m Cu)

Electrical characteristics

Electrical characteristics 6

6.1 **Functional device characteristics**

Electrical characteristics Table 9

| Parameter | Symbol | | Value | S | Un | Note or Test Condition | Number | |
|------------------------------------------------------|--------------------------|------|-------|------|----|---------------------------------------------------------------------------------------------------------------------------------|----------|--|
| | | Min. | Тур. | Max. | it | | | |
| Current Consumption V _{CC} | Power Supply | | | | • | | | |
| Current Consumption in BD_Normal mode | iV _{CC} | _ | 33 | 40 | mA | Transmitter active | P_6.1.1 | |
| Current Consumption in BD_Normal mode | iV _{CC_idle} | _ | 6 | 15 | mA | Transmitter idle; | P_6.1.2 | |
| Current Consumption in BD_Standby mode | iV _{CC_Stb_150} | - | 30 | 50 | μΑ | T _J ≤ 150°C; No bus activity or local errors detected; Logic inputs in default states; ERRN = "high" | P_6.1.3 | |
| Current Consumption in BD_Standby mode | iV _{CC_Stb_85} | - | 17 | 25 | μΑ | $T_J \le 85^{\circ}\text{C}$; No bus activity or local errors detected; Logic inputs in default states; ERRN = "high" | P_6.1.4 | |
| Current Consumption in BD_Off condition | iV _{CC_Off} | _ | _ | 35 | μΑ | Logic inputs in default states; | P_6.1.5 | |
| Current Consumption V _{IO} | Reference | | | | | | | |
| Current Consumption in BD_Normal mode | iV _{IO} | _ | 0.15 | 0.5 | mA | _ | P_6.1.6 | |
| Current Consumption in BD_Standby mode | iV _{IO_Stb} | - | 1 | 8 | μΑ | No bus activity or local errors detected; Logic inputs in default states; ERRN = "high" | P_6.1.7 | |
| Current Consumption in BD_Off condition | iV _{IO_Off} | - | - | 6 | μΑ | Logic inputs in default states | P_6.1.8 | |
| Undervoltage Detection V | CC Power Supply | | | | | | | |
| Undervoltage detection threshold on V _{CC} | uBDUVV _{CC} | 4.0 | 4.25 | 4.75 | V | - | P_6.1.9 | |
| Undervoltage detection hysteresis on V _{CC} | uBDUVV _{CC_Hys} | _ | 100 | - | mV | _ | P_6.1.10 | |
| Power-on reset threshold | uBDPDV _{cc} | 1.5 | 2.5 | 3.5 | ٧ | - | P_6.1.11 | |
| Transition time to BD_Standby mode after power-up | dBD _{Power} | - | 50 | 100 | μs | $V_{\rm CC} > uBDPDV_{\rm CC}$ | P_6.1.12 | |

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Electrical characteristics

Table 9 Electrical characteristics (cont'd)

| Parameter | Symbol | | Value | S | Un | Note or Test Condition | Number |
|-------------------------------------------------------------|-----------------------------------------------------------------------|------|-------|------|----|---------------------------------------------------------------------------|----------|
| | | Min. | Тур. | Max. | it | | |
| Undervoltage filter time | dBDUVV _{CC_blk} | 3 | _ | 10 | μs | 1) | P_6.1.13 |
| Undervoltage detection time | dBDUVV _{CC} | 3 | 40 | 100 | μs | Time between under- voltage event and forced mode change | P_6.1.14 |
| Undervoltage recovery time | dBDRV _{CC} | 3 | 40 | 100 | μs | Time between undervoltage recovery and forced mode change | P_6.1.15 |
| Undervoltage Detection V_{10} | Reference | | | | | | |
| Undervoltage detection threshold on $V_{\rm IO}$ | uUV _{IO} | 2.5 | 2.7 | 3.0 | V | _ | P_6.1.16 |
| Undervoltage detection hysteresis on V_{10} | uBDUVV _{IO_Hys} | - | 30 | - | mV | _ | P_6.1.17 |
| Undervoltage filter time | dBDUVV _{IO_blk} | 1 | - | 10 | μs | 1) | P_6.1.18 |
| Undervoltage detection time | dBDUVV _{IO} | 1 | 40 | 100 | μs | Time between under- voltage event and forced mode change | P_6.1.19 |
| Undervoltage recovery time | dBDRV _{IO} | 1 | 40 | 100 | μs | Time from recovery until possible mode change | P_6.1.20 |
| Digital Output RxD | 1 | | 1 | | | | |
| High level output voltage | uV _{Dig_Out_High_RxD} | 80 | - | 100 | % | Relative to uV_{IO} ; $iRxD_H = -2 \text{ mA}$; | P_6.1.21 |
| Low level output voltage | uV _{Dig_Out_Low_RxD} | - | _ | 20 | % | Relative to uV_{IO} ; $^{2)}$; $iRxD_L = 2 \text{ mA}$; | P_6.1.22 |
| Output voltage while uV_{10} is in undervoltage condition | $uV_{\mathrm{Dig_Out_UV_RxD}}$ | _ | _ | 250 | mV | $uV_{10} < uUV_{10}$; 100 kΩ load to GND; | P_6.1.23 |
| Output voltage while in BD_Off condition | uV _{Dig_Out_Off_RxD} | - | _ | 100 | mV | 100 kΩ load to GND; | P_6.1.24 |
| Rise time on the RxD output | dBDRxD _{R15} | - | 2 | 6 | ns | $20 \% \rightarrow 80\% \text{ of } uV_{10};$ $C_{BDRXD} = 15 \text{ pF}$ | P_6.1.25 |
| Fall time on the RxD output | dBDRxD _{F15} | - | 2 | 6 | ns | 80 % → 20% of uV_{IO} ; $C_{BDRXD} = 15 \text{ pF}$ | P_6.1.26 |
| Rise time on the RxD output | dBDRxD _{R25} | - | 3 | 8 | ns | 20 % \rightarrow 80% of uV_{IO} ; $C_{BDRXD} = 25 \text{ pF}$ | P_6.1.27 |
| Fall time on the RxD output | dBDRxD _{F25} | - | 3 | 8 | ns | $80 \% \rightarrow 20\% \text{ of } uV_{IO};$ $C_{BDRXD} = 25 \text{ pF}$ | P_6.1.28 |
| Sum of rise and fall time on the RxD output | dBDRxD _{R15} + dBDRxD _{F15} | - | 4 | 12 | ns | $C_{\rm BDRxD} = 15 \rm pF;$ | P_6.1.29 |
| Difference of rise and fall time on the RxD output | $ \frac{\left dBDRxD_{R15} - \right.}{\left. dBDRxD_{F15} \right } $ | _ | 1 | 2.5 | ns | $C_{\rm BDRxD} = 15 \rm pF;$ | P_6.1.30 |

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Electrical characteristics

Table 9 Electrical characteristics (cont'd)

| Parameter | Symbol | | Value | S | Un | Note or Test Condition | Number |
|-------------------------------------------------------------|--------------------------------------------------|------|-------|------|----|---------------------------------------------------------------------------|----------|
| | | Min. | Тур. | Max. | it | | |
| Sum of rise and fall time on the RxD output | dBDRxD _{R25} + dBDRxD _{F25} | - | 6 | 13 | ns | $C_{\rm BDRxD} = 25 \rm pF;$ | P_6.1.31 |
| Difference of rise and fall time on the RxD output | dBDRxD _{R25} - dBDRxD _{F25} | _ | 1 | 2.5 | ns | $C_{\rm BDRxD} = 25 \rm pF;$ | P_6.1.32 |
| Digital Output ERRN | | | | | | | |
| High level output voltage | uV _{Dig_Out_High_ERR} | 80 | - | 100 | % | Relative to uV_{IO} ; $iERRN_H = -2 \text{ mA}$; | P_6.1.33 |
| Low level output voltage | uV _{Dig_Out_Low_ERR} | _ | _ | 20 | % | Relative to uV_{10} ; $iERRN_L = 2 \text{ mA}$; | P_6.1.34 |
| Output voltage while uV_{10} is in undervoltage condition | uV _{Dig_Out_UV_ERRN} | _ | _ | 250 | mV | $uV_{IO} < uUV_{IO}$; 100 kΩ load to GND; | P_6.1.35 |
| Output voltage while in BD_Off condition | UV _{Dig_Out_UFF_ERR} | - | - | 100 | mV | 100 kΩ load to GND; | P_6.1.36 |
| Rise time on the ERRN output | dBDERRN _{R25} | _ | 3 | 8 | ns | 1); 20 % \rightarrow 80% of uV_{10} ; $C_{BDERRN} = 25 \text{ pF}$ | P_6.1.37 |
| Fall time on the ERRN output | dBDERRN _{F25} | - | 3 | 8 | ns | 1); 80 % \rightarrow 20% of uV_{10} ; $C_{BDERRN} = 25 \text{ pF}$ | P_6.1.38 |
| Reaction time on the ERRN pin | dReactionTime _E | - | 5 | 30 | μs | - | P_6.1.39 |
| Digital Output SDO | | | | I. | | | |
| High level output voltage | uV _{Dig_Out_High_SDO} | 80 | - | 100 | % | Relative to uV_{IO} ; ²⁾ ; $iSDO_{H} = -2 \text{ mA}$; | P_6.1.40 |
| Low level output voltage | uV _{Dig_Out_Low_SDO} | - | - | 20 | % | Relative to uV_{IO} ; $iSDO_L = 2 \text{ mA}$; | P_6.1.41 |
| Leakage current while in high impedance state | iBDSDO _z | -1 | - | 1 | μΑ | 0V < <i>uSDO</i> < <i>uV</i> _{IO} ; SCSN = "high" | P_6.1.42 |
| Rise time on the SDO output | dBDSDO _{R25} | - | 3 | 8 | ns | 1); 20 % \rightarrow 80% of uV_{10} ; $C_{BDSDO} = 25 \text{ pF}$ | P_6.1.43 |
| Fall time on the SDO output | dBDSDO _{F25} | - | 3 | 8 | ns | 1); 80 % \rightarrow 20% of uV_{10} ; $C_{BDSDO} = 25 \text{ pF}$ | P_6.1.44 |
| Reaction time for setting SDO output to "high impedance" | dSPI _{SDOZ} | _ | _ | 250 | ns | 1) | P_6.1.45 |
| Digital Input TxD | , | | | | | | • |
| Threshold for detecting logical "high" | uBDLogic_1 | - | - | 60 | % | Relative to uV_{10} ; | P_6.1.46 |
| Threshold for detecting logical "low" | uBDLogic_0 | 40 | - | - | % | Relative to uV_{10} ; | P_6.1.47 |
| High level input current | iBDLogic_1 | 20 | _ | 200 | μΑ | - | P_6.1.48 |

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Electrical characteristics

Table 9 Electrical characteristics (cont'd)

| Parameter | Symbol | | Value | S | Un | Note or Test Condition | Number |
|---------------------------------------------------|--------------------------------|------|-------|------|----|---------------------------------------|----------|
| | | Min. | Тур. | Max. | it | | |
| Low level input current | iBDLogic_0 | -1 | - | 1 | μΑ | - | P_6.1.49 |
| Input capacitance on pin TxD | C_BDTxD | _ | _ | 5 | pF | 1) | P_6.1.50 |
| Digital Input TxEN | | | | | 1 | | 1 |
| Threshold for detecting logical "high" | uV _{Dig_In_High_TxEN} | - | - | 70 | % | Relative to <i>uV</i> _{IO} ; | P_6.1.51 |
| Threshold for detecting logical "low" | uV _{Dig_In_Low_TxEN} | 30 | - | - | % | Relative to uV_{10} ; | P_6.1.52 |
| High level input current | i _{Dig_In_High_TxEN} | -1 | - | 1 | μΑ | - | P_6.1.53 |
| Low level input current | i _{Dig_In_Low_TxEN} | -200 | - | -20 | μΑ | - | P_6.1.54 |
| Input capacitance on pin TxEN | C_BDTxEN | - | - | 5 | pF | 1) | P_6.1.55 |
| Maximum transmitter activation time | dBDTxActiveMa x | 1500 | - | 2600 | μs | - | P_6.1.56 |
| Digital Input BGE | · | 1 | 1 | 1 | | , | 1 |
| Threshold for detecting logical "high" | uV _{Dig_In_High_BGE} | - | - | 70 | % | Relative to <i>uV</i> _{IO} ; | P_6.1.57 |
| Threshold for detecting logical "low" | uV _{Dig_In_Low_BGE} | 30 | - | _ | % | Relative to uV_{10} ; | P_6.1.58 |
| High level input current | i _{Dig_In_High_BGE} | 20 | - | 200 | μΑ | - | P_6.1.59 |
| Low level input current | i _{Dig_In_Low_BGE} | -1 | - | 1 | μΑ | - | P_6.1.60 |
| Transmitter activation delay BGE, Idle → active | dBDBGEia | - | 50 | 75 | ns | $R_{\rm DCLOAD} = 40 \Omega$ | P_6.1.61 |
| Transmitter deactivation delay BGE, Active → idle | dBDBGEai | - | 50 | 75 | ns | $R_{\rm DCLOAD} = 40 \Omega$ | P_6.1.62 |
| Input capacitance on pin BGE | C_BDBGE | - | - | 5 | pF | 1) | P_6.1.63 |
| Digital Input STBN | | | | | | | |
| Threshold for detecting logical "high" | uV _{Dig_In_High_STBN} | - | - | 70 | % | Relative to <i>uV</i> _{IO} ; | P_6.1.64 |
| Threshold for detecting logical "low" | uV _{Dig_In_Low_STBN} | 30 | - | _ | % | Relative to uV_{10} ; | P_6.1.65 |
| High level input current | i _{Dig_In_High_STBN} | 20 | _ | 200 | μΑ | - | P_6.1.66 |
| Low level input current | i _{Dig_In_Low_STBN} | -1 | - | 1 | μΑ | - | P_6.1.67 |
| Mode transition time after applying host command | $dBD_{ModeChange}$ | - | - | 100 | μs | - | P_6.1.68 |

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Electrical characteristics

Table 9 Electrical characteristics (cont'd)

| Parameter | Symbol | | Value | s | Un | Note or Test Condition | Number | |
|-----------------------------------------------------------------------|--------------------------------|------|-------|------|----|-----------------------------------------------------------------------------------|----------|--|
| | | Min. | Тур. | Max. | it | | | |
| Filter time for detection of host commands | dBDLogic _{Filter} | 2 | - | 6 | μs | - | P_6.1.69 | |
| Input capacitance on pin STBN | C_BDSTBN | _ | - | 5 | pF | 1) | P_6.1.70 | |
| Digital Input SCLK | | | | | | | | |
| Threshold for detecting logical "high" | uV _{Dig_In_High_SCLK} | - | - | 70 | % | Relative to uV_{IO} ; | P_6.1.71 | |
| Threshold for detecting logical "low" | uV _{Dig_In_Low_SCLK} | 30 | - | _ | % | Relative to uV_{10} ; | P_6.1.72 | |
| High level input current | i _{Dig_In_High_SCLK} | 20 | _ | 200 | μΑ | - | P_6.1.73 | |
| Low level input current | i _{Dig_In_Low_SCLK} | -1 | _ | 1 | μΑ | - | P_6.1.74 | |
| SPI clock period | dSPI _{Clock} | 0.25 | _ | 100 | μs | - | P_6.1.75 | |
| SPI enable time | dSPI _{Lead} | 250 | _ | - | ns | - | P_6.1.76 | |
| SPI enable time | dSPI _{LeadStbOK} | 4 | _ | - | μs | BD_Standby mode; No Wake or errors detected; STBN = "low"; ERRN = "high" | P_6.1.77 | |
| SPI disable time | dSPI _{Lag} | 250 | _ | - | ns | $C_{\rm BDSDO} = 25 \rm pF$ | P_6.1.78 | |
| Input capacitance on pin SCLK | C_BDSCLK | _ | - | 5 | pF | 1) | P_6.1.79 | |
| Digital Input SCSN | | | | | | | | |
| Threshold for detecting logical "high" | uV _{Dig_In_High_SCSN} | _ | - | 70 | % | Relative to uV_{10} ; | P_6.1.80 | |
| Threshold for detecting logical "low" | uV _{Dig_In_Low_SCSN} | 30 | - | - | % | Relative to uV_{10} ; | P_6.1.81 | |
| High level input current | i _{Dig_In_High_SCSN} | -1 | _ | 1 | μΑ | - | P_6.1.82 | |
| Low level input current | i _{Dig_In_Low_SCSN} | -200 | _ | -20 | μΑ | - | P_6.1.83 | |
| SPI timeout | $dSPI_{Timeout}$ | 2.1 | _ | 4 | ms | _ | P_6.1.84 | |
| SPI Interframe space | dSPI _{Interframe} | 10 | _ | _ | μs | Break between consecutive SPI readouts | P_6.1.85 | |
| Input capacitance on pin SCSN | C_BDSCSN | - | - | 5 | pF | 1) | P_6.1.86 | |
| Bus Transmitter, BP and BN | 1 | + | | ! | 1 | 1 | - | |
| Absolute differential output voltage while sending; Data_0 and Data_1 | uBDTx _{active} | 0.6 | _ | 2.0 | V | $40 \Omega < R_{\rm DCLOAD} < 55 \Omega;^{4)}$ | P_6.1.87 | |

FlexRay Transceiver



Electrical characteristics

Electrical characteristics (cont'd) Table 9

| Parameter | Symbol | | Value | S | Un | Note or Test Condition | Number | |
|-------------------------------------------------------------------------------------------------------|-----------------------------------|------|-------|-------|----|--------------------------------------------|-----------|--|
| | | Min. | Тур. | Max. | it | | | |
| BP short circuit current Short to GND, Absolute value | <i>iBP</i> _{GNDShortMax} | - | 20 | 60 | mA | _ | P_6.1.88 | |
| BP short circuit current Short to -5 V, Absolute value | iBP _{-5ShortMax} | _ | 40 | 60 | mA | - | P_6.1.89 | |
| BP short circuit current Short to 27 V, Absolute value | iBP _{BAT27ShortMax} | - | 25 | 60 | mA | _ | P_6.1.90 | |
| BP short circuit current Short to BM, Absolute value | iBP _{BMShortMax} | - | 35 | 60 | mA | _ | P_6.1.91 | |
| BM short circuit current Short to GND, Absolute value | <i>iBM</i> _{GNDShortMax} | - | 20 | 60 | mA | _ | P_6.1.92 | |
| BM short circuit current Short to -5 V, Absolute value | iBM _{-5ShortMax} | - | 40 | 60 | mA | _ | P_6.1.93 | |
| BM short circuit current Short to 27 V, Absolute value | iBM _{BAT27ShortMax} | _ | 25 | 60 | mA | _ | P_6.1.94 | |
| BM short circuit current Short to BP, Absolute value | <i>iBM</i> _{BPShortMax} | - | 35 | 60 | mA | - | P_6.1.95 | |
| Transmitter delay negative voltage | dBDTx10 | - | 35 | 50 | ns | $R_{\rm DCLOAD} = 40 \ \Omega;^{3)};^{4)}$ | P_6.1.96 | |
| Transmitter delay positive voltage | dBDTx01 | - | 35 | 50 | ns | $R_{\rm DCLOAD} = 40 \ \Omega;^{3)};^{4)}$ | P_6.1.97 | |
| Transmitter delay mismatch dBDTxAsym = dBDTx10 - dBDTx01 | dBDTxAsym | - | _ | 4 | ns | $R_{\text{DCLOAD}} = 40 \Omega;$ | P_6.1.98 | |
| Fall time differential bus voltage (80% → 20%) | dBusTx10 | 6 | 13 | 18.75 | ns | $R_{\rm DCLOAD} = 40 \ \Omega;^{4)}$ | P_6.1.99 | |
| Rise time differential bus voltage (20% → 80%) | dBusTx01 | 6 | 13 | 18.75 | ns | $R_{\rm DCLOAD} = 40 \ \Omega;^{4)}$ | P_6.1.100 | |
| Difference between differential bus voltage rise time and fall time dBusTxDiff = dBusTx01 - dBusTx10 | dBusTxDiff | - | - | 3 | ns | $R_{\rm DCLOAD} = 40 \Omega;$ | P_6.1.101 | |
| Transmitter delay Idle → active | dBDTxia | _ | 40 | 75 | ns | $R_{\rm DCLOAD} = 40 \Omega;$ | P_6.1.102 | |
| Transmitter delay Active → idle | dBDTxai | - | 45 | 75 | ns | $R_{\rm DCLOAD} = 40 \Omega;$ | P_6.1.103 | |

FlexRay Transceiver



Electrical characteristics

Table 9 Electrical characteristics (cont'd)

| Parameter | Symbol | | Value | S | Un | Note or Test Condition | Number | |
|--------------------------------------------------------------|-----------------------------------|------|-------|------|----|-----------------------------------------------------------------------------------------------|-----------|--|
| | | Min. | Тур. | Max. | it | | | |
| Transmitter delay mismatch dBDTxDM = dBDTxai - dBDTxia | dBDTxDM | -30 | _ | 30 | ns | $R_{\rm DCLOAD} = 40 \Omega;$ | P_6.1.104 | |
| Transition time Idle → active | dBusTxia | - | 10 | 30 | ns | $R_{\rm DCLOAD} = 40 \Omega;$ | P_6.1.105 | |
| Transition time Active → idle | dBusTxai | - | 10 | 30 | ns | $R_{\rm DCLOAD} = 40 \Omega;$ | P_6.1.106 | |
| Bus Receiver, BP and BM | | | | | | | | |
| Receiver threshold for detecting Data_1 | uData1 | 150 | - | 300 | mV | -10 V < <i>uCM</i> < 15 V; | P_6.1.107 | |
| Receiver threshold for detecting Data_0 | uData0 | -300 | - | -150 | mV | -10 V < uCM < 15 V; | P_6.1.108 | |
| Mismatch of receiver thresholds | uData1 - uData0 | -30 | - | 30 | mV | (uBP + uBM) / 2 = 2.5 V; | P_6.1.109 | |
| Common mode voltage range uCM = (uBP + uBM) /2 | иСМ | -10 | _ | 15 | V | 5), | P_6.1.110 | |
| Filter time for bus idle detection | dBDIdleDetectio n | 50 | - | 200 | ns | <i>uBus</i> = 900 mV → 30 mV; | P_6.1.111 | |
| Filter time for bus active detection | dBDActivityDete ction | 100 | - | 250 | ns | <i>uBus</i> = 30 mV → 900 mV; | P_6.1.112 | |
| Receiver common mode input resistance | $R_{\rm CM1}, R_{\rm CM2}$ | 10 | - | 40 | kΩ | Bus idle; open load; | P_6.1.113 | |
| Receiver differential input resistance | $R_{\text{CM1}} + R_{\text{CM2}}$ | 20 | - | 80 | kΩ | Bus idle; open load; | P_6.1.114 | |
| Absolute differential busidle voltage | uBDTx _{Idle} | 0 | _ | 30 | mV | TxEN = "high"; $40 \Omega < R_{DCLOAD} < 55 \Omega$; | P_6.1.115 | |
| Idle voltage at BP and BM BD_Normal mode | uBias _{Non-LowPower} | 1.8 | 2.5 | 3.2 | V | TxEN = "high"; $^{6)}$; 40 Ω < R_{DCLOAD} < 55 Ω; | P_6.1.116 | |
| Idle voltage at BP and BM BD_Standby mode | uBias _{LowPower} | -100 | 0 | 100 | mV | $40 \Omega < R_{\rm DCLOAD} < 55 \Omega;^{6};$ | P_6.1.117 | |
| Absolute leakage current on BP when in BD_Off condition | iBP _{Leak} | _ | 7 | 15 | μΑ | uBP = uBM = 5 V; All other pins connected to GND. GND pin connected directly to 0 V; | P_6.1.118 | |
| Absolute leakage current on BM when in BD_Off condition | <i>iBM</i> _{Leak} | - | 7 | 15 | μΑ | uBP = uBM = 5 V; All other pins connected to GND. GND pin connected directly to 0 V; | P_6.1.119 | |

FlexRay Transceiver



Electrical characteristics

Table 9 Electrical characteristics (cont'd)

| Parameter | Symbol | | Value | S | Un | Note or Test Condition | Number |
|-------------------------------------------------------------------|-------------------------------|------|-------|------|----|-----------------------------------------------------------------------------------------------------|-----------|
| | | Min. | Тур. | Max. | it | | |
| Absolute BP leakage current loss of GND | <i>iBP</i> _{LeakGND} | _ | 500 | 1600 | μΑ | uBP = uBM = 0 V; All other pins connected via 0Ω to $16 \text{ V};$ | P_6.1.120 |
| Absolute BM leakage current loss of GND | iBM _{LeakGND} | _ | 500 | 1600 | μΑ | uBP = uBM = 0 V; All other pins connected via 0Ω to $16 \text{ V};$ | P_6.1.121 |
| Receiver delay, negative edge | dBDRx10 | _ | 60 | 75 | ns | C _{BDRxD} = 25 pF; (see Figure 18); | P_6.1.122 |
| Receiver delay, positive edge | dBDRx01 | _ | 60 | 75 | ns | C _{BDRxD} = 25 pF; (see Figure 18); | P_6.1.123 |
| Receiver delay mismatch dBDRxAsym = dBDRx10 - dBDRx01 | dBDRxAsym | _ | _ | 5 | ns | (uBP + uBM) / 2 = 2.5 V; C _{BDRxD} = 25 pF; ⁷⁾ ; (see Figure 18); | P_6.1.124 |
| Idle reaction time | dBDRxai | 50 | _ | 250 | ns | (see Figure 19); | P_6.1.125 |
| Activity reaction time | dBDRxia | 100 | - | 300 | ns | (see Figure 19); | P_6.1.126 |
| Idle Loop Delay dBDTxRxai = dBDTxai + dBDR xai | dBDTxRxai | _ | _ | 325 | ns | _ | P_6.1.127 |
| BP output current, Bus idle | <i>iBP</i> _{Idle} | -5.0 | _ | 5.0 | mA | -27 V < uBP < 27 V; | P_6.1.128 |
| BM output current, Bus idle | <i>iBM</i> _{Idle} | -5.0 | - | 5.0 | mA | -27 V < uBM < 27 V; | P_6.1.129 |
| Input capacitance on pin BP | C_BDBP | _ | - | 30 | pF | $^{1)}$; uBP = 100 mV; $f_{\text{Test}} = 5 \text{ MHz}$; | P_6.1.130 |
| Input capacitance on pin BM | C_BDBM | _ | _ | 30 | pF | $f_{\text{Test}} = 5 \text{ MHz};$ | P_6.1.131 |
| Differential bus input capacitance | C_BDBus | _ | _ | 20 | pF | $f_{\text{Test}} = 5 \text{ MHz};$ | P_6.1.132 |
| Remote Wake-up Detection | , BP and BM | | | | | | |
| Low-power receiver threshold for detecting Data_0 | uData0_LP | -400 | _ | -100 | mV | - | P_6.1.133 |
| Acceptance time-out of a Data_0 phase in wake-up pattern | dWU _{0Detect} | 1 | _ | 4 | μs | _ | P_6.1.134 |
| Acceptance time-out of an Idle or Data_1 phase in wake-up pattern | dWU _{IdleDetect} | 1 | _ | 4 | μs | _ | P_6.1.135 |
| Acceptance time-out for wake-up pattern recognition | dWU _{Timeout} | 48 | - | 140 | μs | _ | P_6.1.136 |

FlexRay Transceiver



Electrical characteristics

Table 9 Electrical characteristics (cont'd)

| Parameter | Symbol | | Value | S | Un | Note or Test Condition | Number | |
|---------------------------------------|---------------------------|------|-------|------|----|-------------------------------|-----------|--|
| | | Min. | Тур. | Max. | it | | | |
| Acceptance time-out for interruptions | dWU _{Interruptt} | 0.13 | _ | 1 | μs | 8) | P_6.1.137 | |
| Reaction time after wake-up | dBDWakeupRea | _ | _ | 100 | μs | _ | P_6.1.138 | |
| | ction _{Remote} | | | | | | | |

- 1) Not subject to production test, specified by design
- 2) No undervoltage on V_{10} . V_{CC} supplied
- 3) For all TxD signals with a sum of rise and fall time (20% 80% uV_{10}) of up to 9ns
- 4) The TxD signal is constant for 100 ns ... 4400 ns before the first edge and also in case the test is performed with the opposite polarity
- 5) Tested on a receiving bus driver. Sending bus driver has a ground offset voltage in the range of [-12.5 V to +12.5 V] and sends a 50 / 50 pattern
- 6) Bus Driver connected to GND and $uV_{CC} = 5 \text{ V}$
- 7)For ±300 mV as well as ±150 mV levels of uBUS
- 8) When the phase that is interrupted was continuously present for at least 870 ns

Electrical characteristics

Diagrams 6.2

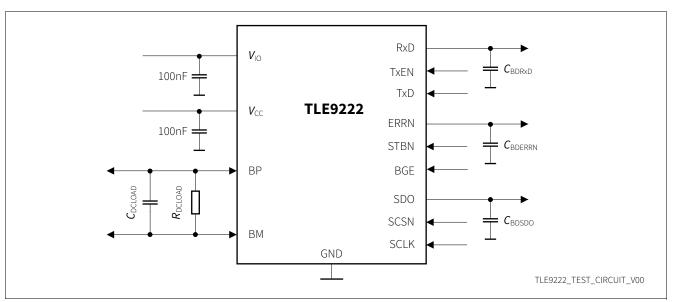


Figure 15 Simplified test circuit

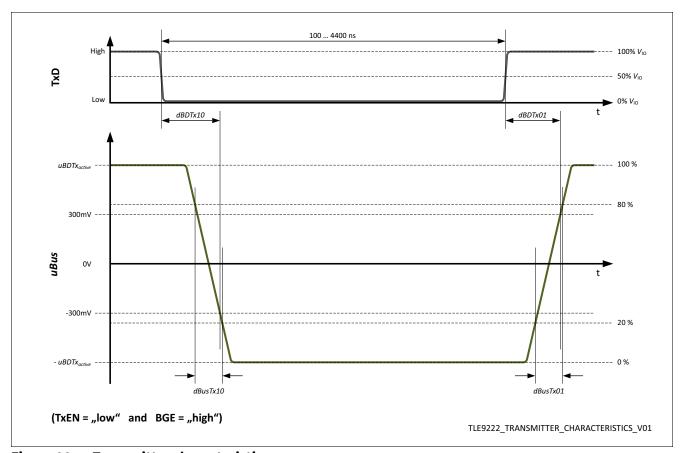


Figure 16 **Transmitter characteristics**



Electrical characteristics

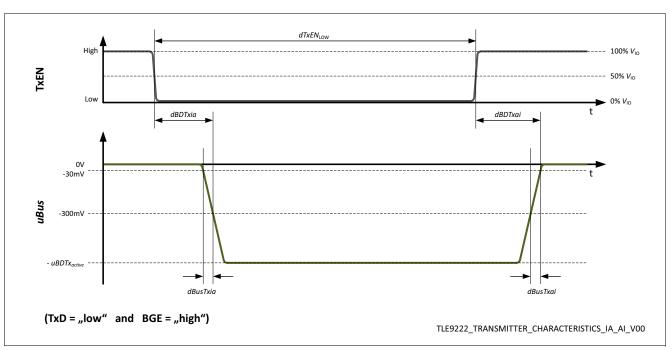


Figure 17 Transmitter characteristics from "idle" to "active" and vice versa

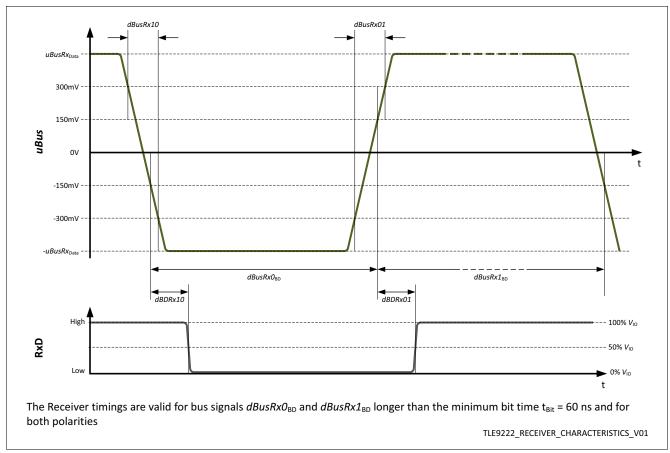


Figure 18 Receiver timing characteristics

FlexRay Transceiver



Electrical characteristics

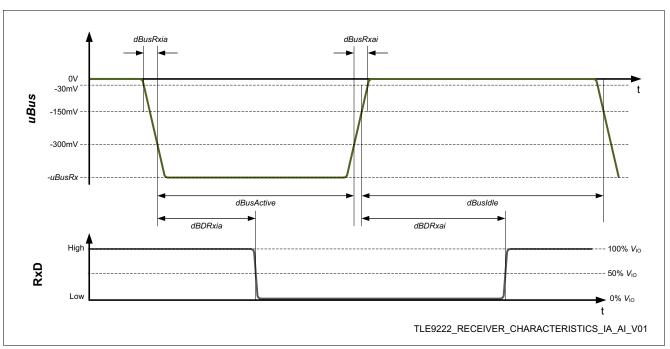


Figure 19 Receiver characteristics from "idle" to "active" and vice versa

(infineon

Application information

7 Application information

Note:

The following information is given as a hint for the implementation of the device only and shall not be regarded as a description or warranty of a certain functionality, condition or quality of the device.

7.1 ESD robustness according to IEC61000-4-2

Tests for ESD robustness according to IEC61000-4-2 "Gun test" (150 pF, 330 Ω) have been performed. The results and test conditions are available in a separate test report.

Table 10 ESD Robustness according to IEC61000-4-2

| Performed Test | Symbol | Result | Unit | Comment |
|-------------------------------------------------------------|---------------------|--------|------|----------------|
| Electrostatic discharge voltage at pin BM and BP versus GND | uESD _{IEC} | ≥8 | kV | Positive pulse |
| Electrostatic discharge voltage at pin BM and BP versus GND | uESD _{IEC} | ≤ -8 | kV | Negative pulse |

7.2 Bus interface simulation model parameter

The simulated value $R_{\rm BDTransmitter}$ describes the equivalent bus driver output impedance.

```
R_{\text{BDTransmitter}} = 50\Omega \times (uBus_{100} - uBus_{40}) / (2.5 \times uBus_{40} - uBus_{100})

uBus_{100} =  differential output voltage on a 100\Omega \mid \mid 100\text{pF} load, while driving "Data_1" to the bus. Value based on simulation.

uBus_{40} =  differential output voltage on a 40\Omega \mid \mid 100\text{pF} load, while driving "Data_1" to the bus. Value based on simulation.

TLE9222_SIMULATION_V00
```

Figure 20 Bus driver output resistance

Table 11 Simulation parameters 1)

| Parameter | Symbol | Value | S | | Unit | Note / Test Condition | |
|-------------------------------------------------------|----------------------------|-------|------|------|------|------------------------------|--|
| | | Min. | Тур. | Max. | | | |
| Bus interface simulation resistor | R _{BDTransmitter} | 30 | 100 | 500 | Ω | - | |
| RxD signal difference of rise and fall time at TP4_CC | _ | - | _ | 5 | ns | - | |

¹⁾ Simulated value for reference purposes only.



Application information

7.3 Application example

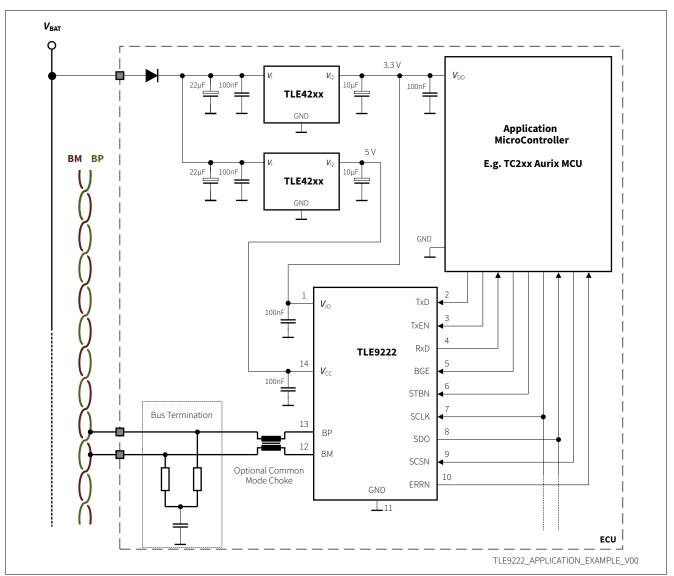


Figure 21 Simplified application example

infineon

Application information

7.4 Implementation of ECU functional safety concepts

The TLE9222 has been implemented with features for alleviating the development of functional safety requirements on a system level. The top level objective is to ensure a malfunctioning ECU is put in a safe state, which for the FlexRay transceiver means no bus disturbance.

This is realized by the Bus Guardian interface, which controls the bus transmitter directly at the driver stages. The TLE9222 is also implemented with a redundant diagnostic path for detecting the true state of the bus transmitter. This status is multiplexed back to the ERRN output, which is set "low" when the transmitter is reliably disabled. By taking advantage of this safety feature, the ECU diagnostic coverage can be increased.

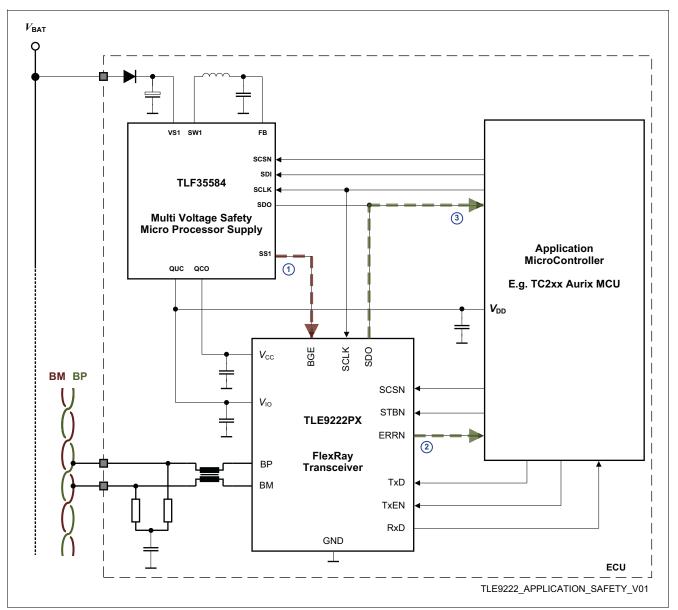


Figure 22 Application diagram

In **Figure 22** an application example of an Automotive ECU for safety critical applications is shown. Together with a Safety MCU Supply IC, e.g. the Infineon TLF35584, that incorporates safe state control functionality, the BGE input of the TLE9222 is connected to the safe state output. If the Safety Supply IC detects unexpected behavior at the supply voltages or incorrect MCU behavior through the functional watchdog, the TLE9222 makes sure there is no influence to the FlexRay bus after the BGE input is set "low". Additionally, the microcontroller can detect the true state of the transceiver output drivers from the ERRN out, which should

FlexRay Transceiver



Application information

trigger a SPI readout of the status register. By observing the BGE flag being set "low", the MCU has verified that the TLE9222 has been safely disconnected from the bus by the Safety Supply IC.

It is recommended to follow these steps for the ECU software implementation. After ECU power-up, the MCU should test and verify the correct behavior of the fail safe state as a part of its initialization routine, before releasing the transceiver for bus access and transmission.

7.5 Minimizing ECU current consumption through BD_Standby mode

The very low current consumption of $iV_{\text{CC_Stb_85}}$ and $iV_{\text{CC_Stb_150}}$ of the TLE9222 can only be reached with the correct system implementation and software control. While operating in ECU low power mode with the TLE9222 in BD_Standby mode, the logic inputs should be in their default states (See **Table 2**). This prevents current to flow through the implemented pull-up / pull-down circuits. Secondly, the logic outputs, RxD and ERRN, should be in their default condition "high" for BD_Standby mode (See **Table 4**). After the TLE9222 is set to BD_Standby mode, it is recommended to perform a SPI readout for verifying correct state transition and to clear pending diagnosis flags.

A MCU in low-power mode should continuously (by interrupt) or periodically (by polling) monitor the ERRN output for wake-up information. Even if the wake-up function is not being used, the MCU should clear the flags of the status register by SPI readout. For simpler ECU implementations, not using the SPI interface, a mode change cycle to BD_Normal mode and back to BD_Standby mode again has the same effect.

7.6 Further application information

- · Please contact us for information regarding the pin FMEA
- For further information you may contact http://www.infineon.com/



Package outlines

8 Package outlines

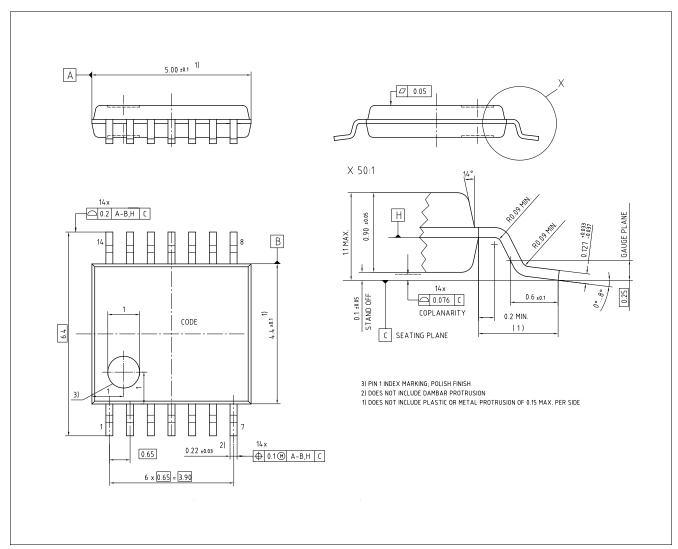


Figure 23 PG-TSSOP-14



Package outlines

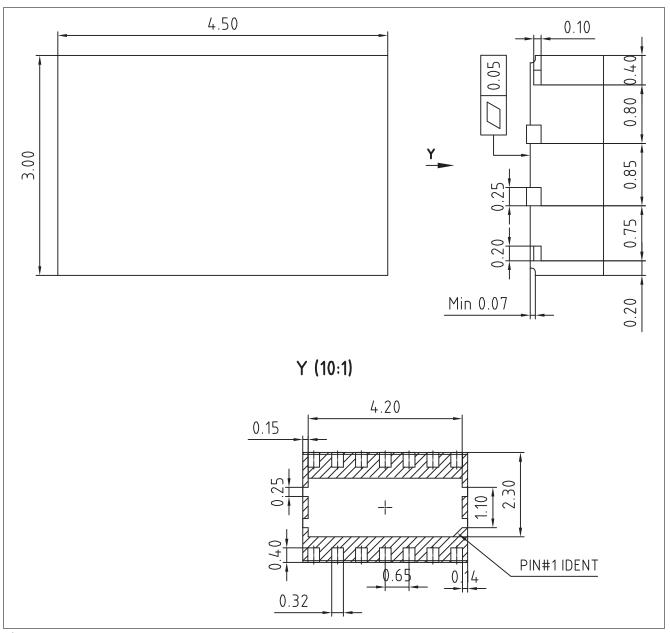


Figure 24 PG-TSON-14

Green product (RoHS compliant)

To meet the world-wide customer requirements for environmentally friendly products and to be compliant with government regulations the device is available as a green product. Green products are RoHS-Compliant (i.e Pb-free finish on leads and suitable for Pb-free soldering according to IPC/JEDEC J-STD-020).

FlexRay Transceiver



Revision history

9 Revision history

| Revision | Date | Changes |
|----------|------------|--------------------------------------------------------------------------------------|
| 1.2 | 2017-10-04 | Editorial changes |
| | | Product Code corrected |
| | | Applications added on frontcover |
| | | Parameter R_{thJA} for PG-TSON-14 package added |
| 1.1 | 2017-05-18 | • Current Consumption in BD_Off condition changed (iV_{IO_Off}). |
| | | • Current Consumption in BD_Standbymode changed (iV_{IO_Stb}). |
| | | Absolute differential output voltage while sending; |
| | | Data_0 and Data_1 changed (uBDTx _{active}). |
| | | • Current Consumption in BD_Standbymode changed (<i>iV</i> _{CC_Stb_150}). |
| | | PG-TSON-14 added. |
| 1.0 | 2015-07-02 | Initial release |

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